

JY2605M

Dual N Channel Enhancement Mode Power MOSFET

GENERAL DESCRIPTION

The product utilizes the latest trench processing techniques to achieve the high cell density and reduces the on-resistance with low gate charge. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications.

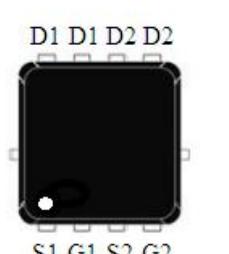
FEATURES

- 60V/50A, $R_{DS(ON)} = 14m\Omega$ @ $V_{GS} = 10V$ (typical)
- Fast switching and reverse body recovery
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

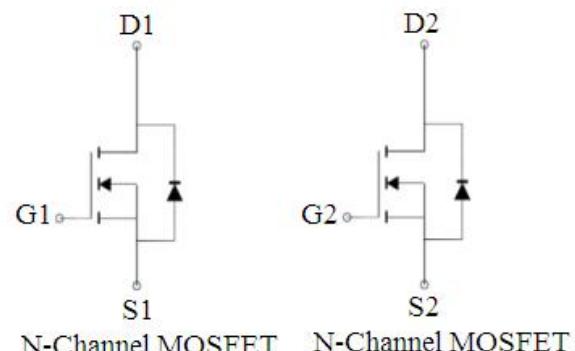
APPLICATIONS

- Power Switching application
- Synchronous rectification
- Motor drive for 12V-24V Systems

PIN DESCRIPTION



DFN 5*6



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Absolute Maximum Ratings(Tc=25° C Unless Otherwise Noted)

Symbol	Parameter		Limit	Unit
V _{DS}	Drain-Source Voltage		60	V
V _{GS}	Gate-Source Voltage		±20	V
I _D	Continuous Drain Current	Tc=25° C	50	A
		Tc=100° C	35	
I _{DM}	Pulsed Drain Current		185	A
P _D	Maximum Power Dissipation		65	W
T _J T _{STG}	Operating Junction and Storage Temperature Range		-55 to +175	°C
R _{θJC}	Thermal Resistance-Junction to Case		2.3	°C/W

Electrical Characteristics(Ta=25° C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	60			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _{DS} =250uA	1	1.7	2.5	V
R _{DS(ON)}	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =15A		14	18	mΩ
		V _{GS} =4.5V, I _{DS} =8A		18	22	

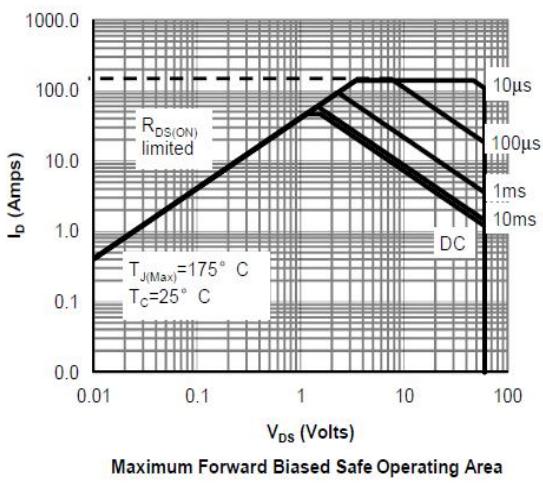
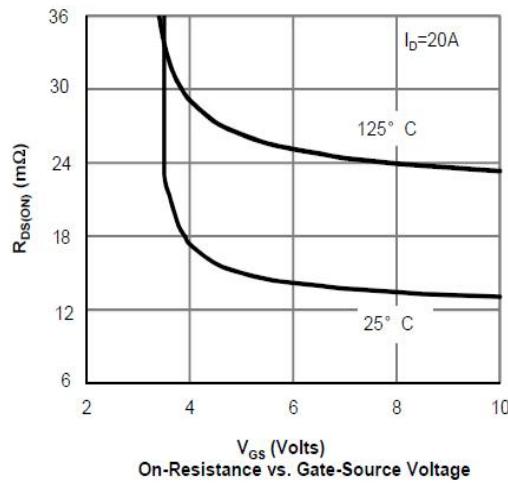
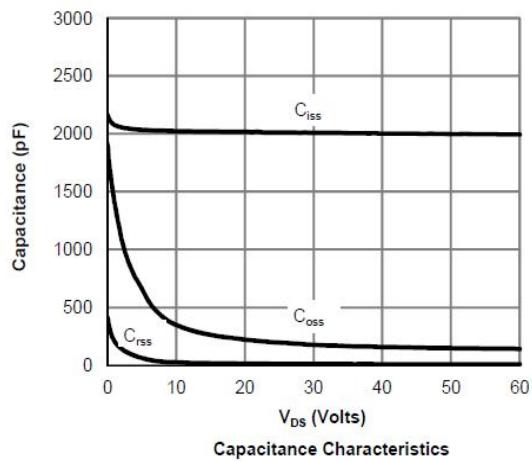
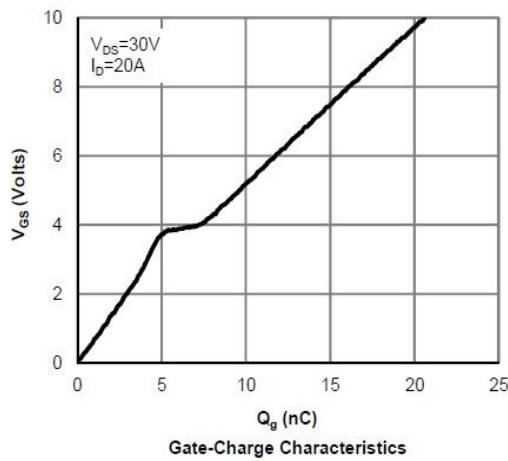
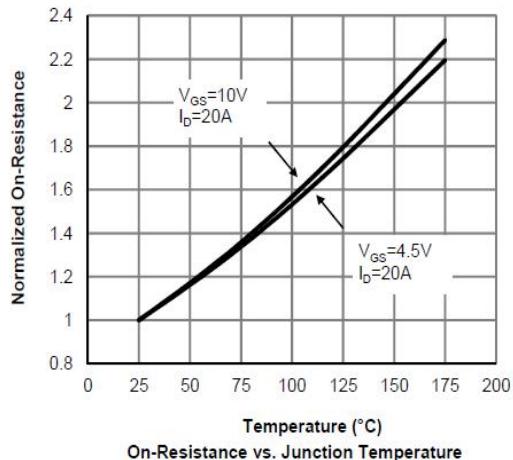
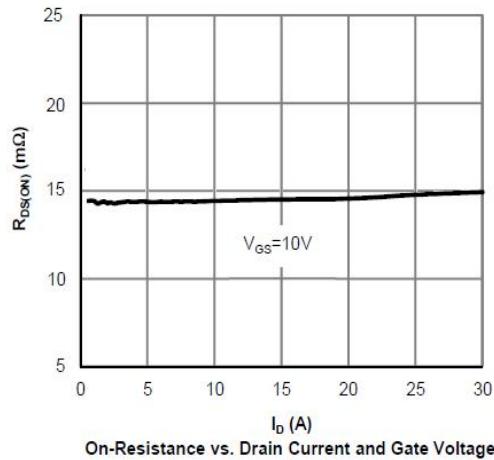
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Electrical Characteristics(T_a=25°C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Drain-Source Diode Characteristics						
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _{SD} =20A			1.2	V
Tr _r	Reverse Recovery Time	I _{SD} =20A di/dt=100A/us		36		ns
Q _{rr}	Reverse Recovery Charge			40		nC
Dynamic Characteristics						
T _{d(on)}	Turn-on Delay Time	V _{DS} =30V, R _G =3Ω, I _{DS} =20A, V _{GS} =10V,		8		ns
Tr	Turn-on Rise Time			6.2		
T _{d(off)}	Turn-off Delay Time			28		
T _f	Turn-off Fall Time			5		
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		2000		pF
C _{oss}	Output Capacitance			160		
C _{RSS}	Reverse Transfer Capacitance			55		
Q _g	Total Gate Charge	V _{DS} =30V, I _D =20A, V _{GS} =10V		21	28	nC
Q _{gs}	Gate-Source Charge			7		
Q _{gd}	Gate-Drain Charge			5		

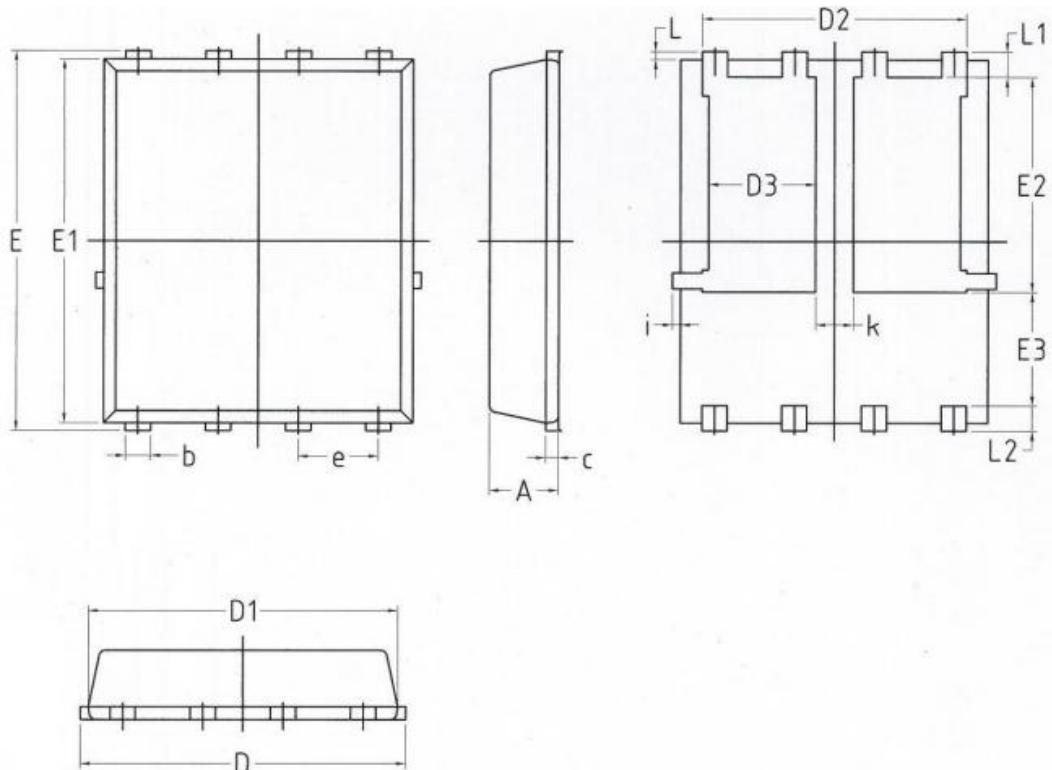
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Typical electrical and thermal characteristics



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DFN5*6 Package Outline



SYMBOL	COMMON			
	MM		INCH	
	MIN.	MAX.	MIN.	MAX.
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.203 BSC		0.0080 BSC	
D	4.80	5.40	0.1890	0.2126
D1	4.80	5.00	0.1890	0.1969
D2	4.11	4.31	0.1620	0.1700
D3	1.60	1.80	0.0629	0.0708
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	3.30	3.50	0.1300	0.1378
E3	1.70	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0019	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
i	/	0.18	/	0.0070
k	0.5	0.7	0.0197	0.0276